Thin film thermistor

The JT series thermistor features high accuracy and a thickness of less than 500 µm. The JT thermistor also has excellent electrical insulation and can be safely used in environments where it might come in contact with electrodes.

Dimensions

Fig. 1

Fig. 2

Product number explanation



Applications

Battery packs, battery chargers, IT equipment, mobile devices, LCDs, surface temperature sensors, high sensitivity air temperature sensors

Specifications

Product number	R_{25}^{1}	R ₂₅ tolerance	B value ²	Dissipation factor (mw / °C)	Thermal time constant (s) ³	Rated power at 25 °C (mW)	Operating temperature range (℃)
103JT	10.0 kΩ	± 1%	3435 K ± 1%	approx. 0.7	opprov. E	2.5	- 50 to 125
104JT	100 kΩ	± 170	4390 K ± 1%	approx. 0.7	approx. 5	3.5	- 50 10 125

¹: Rated zero-power resistance at 25 °C ²: B value calculated from rated zero-power resistance at 25 °C and 85 °C ³: Time required to reach 63.2% of temperature difference. Measured with sensor suspended in mid-air.

Reliability data

Item	Test conditions	Criteria	
Resistance to soldering heat	5 s at 260 ℃	ΔR , $\Delta B \pm 1\%$	
Solderability	2 s at 245 °C Flux material: Rosin 25%, ethyl alcohol 75%	More than 90% soldered	
Tensile strength (lead wire)	10 s at 1 N (horizontal pull)		
Termination bending	2.5 N, one time, 90°	$\Delta R, \Delta B \pm$ 1% and visual	
Free fall	Three times natural fall to a maple board from 0.75 m height.	inspection	
Voltage proof	100 V AC for one minute	Less than 1 mA	
Insulation resistance	100 V DC	Over 100 MΩ	
Dry heat	1000 hours at 125 °C		
Damp heat (under electrical load)	1000 hours at 40 °C and 90% humidity Electrical load: 1 mA DC		
Temperature cycle (thermal shock)	100 cycles as below: 1 25 °C for 30 minutes 2. Room temperature for 3 minutes 3. 125 °C for 30 minutes 4. Room temperature for 3 minutes	ΔR, ΔB ± 1%	

Caution

- If you plan pressing or pushing the thermistor against an object or inserting it into a tight space please contact SEMITEC sales staff.
- When soldering make sure to avoid contact of the hot part (over 150 °C) and the sensor, because this may melt the sensor film.
- When bending the sensor make sure to not apply force on the sensor head (minimum distance from sensor: 3 mm) when fixing it. Additionally, make sure to bend the lead wire with a minimum distance of 7 mm from the sensor head.

Resistance / temperature characteristics

100

nax

0.5 r

Proprietary glue

Insulation film

Tin plated 42 alloy

Unit: mm

 (\cdot)

(0.17)

Temperature	Product number			
(°C)	103JT	104JT		
- 50	367.7	9584		
- 40	204.7	4572		
- 30	118.5	2282		
- 20	71.02	1191		
- 10	43.67	647.2		
0	27.70	365.0		
10	18.07	212.5		
20	12.11	127.7		
25	10.00	100.0		
30	8.301	78.88		
40	5.811	50.03		
50	4.147	32.51		
60	3.011	21.61		
70	2.224	14.66		
80	1.668	10.13		
85	1.451	8.483		
90	1.267	7.135		
100	0.9753	5.111		
110	0.7597	3.720		
120	0.5981	2.746		
125	0.5331	2.371		
B _{25/85}	3435 K	4390 K		

